

II. Amendments to the Specification

Please insert the following paragraph before the heading "Technical Field of the Invention".

RELATED APPLICATION

This application is a divisional of Application Serial No. 09/949,188 filed September 7, 2001.

Please amend the Abstract of the Specification as shown below:

ABSTRACT

A ~~method for attaching a~~ sensing device attached to a substrate at a pre-determined distance from the substrate is provided. The ~~method~~ sensing device preferably includes ~~providing a compliant adhesive and depositing a first layer of the compliant adhesive~~ attached to onto the substrate and having a pre-determined thickness, a sensing device mounted to the first layer of adhesive, curing the first layer of the compliant adhesive, depositing and a second layer of the compliant adhesive directly onto the first layer of the compliant adhesive, inserting the sensing device into the second layer of the compliant adhesive and curing the second layer of the compliant adhesive disposed between the sensing device and the first layer of adhesive to secure the sensing device to the first layer of adhesive.